

TOSHIBA Field Effect Transistor Silicon P Channel MOS Type

SSM6P15FE

High Speed Switching Applications
Analog Switch Applications

- Small package
- Low ON resistance : Ron = 12 Ω (max) (@VGS = -4 V)
: Ron = 32 Ω (max) (@VGS = -2.5 V)

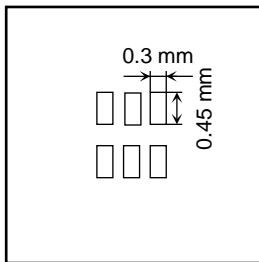
Absolute Maximum Ratings (Ta = 25°C) (Q1, Q2 Common)

Characteristics		Symbol	Rating	Unit
Drain-Source voltage		V _{DS}	-30	V
Gate-Source voltage		V _{GSS}	±20	V
Drain current	DC	I _D	-100	mA
	Pulse	I _{DP}	-200	
Drain power dissipation (Ta = 25°C)		P _D (Note 1)	150	mW
Channel temperature		T _{ch}	150	°C
Storage temperature range		T _{stg}	-55 to 150	°C

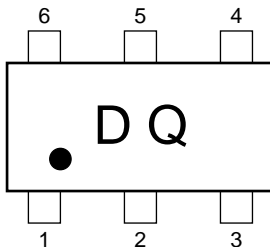
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

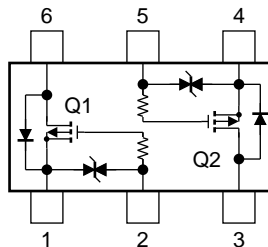
Note 1: Total rating, mounted on FR4 board
(25.4 mm × 25.4 mm × 1.6 mm t, Cu Pad: 0.135 mm² × 6)



Marking



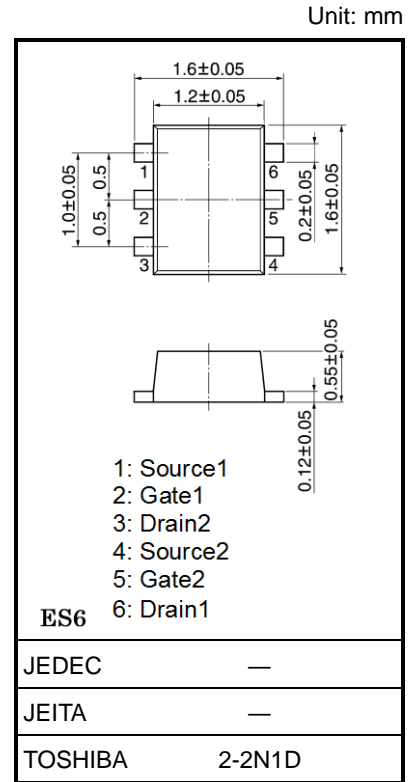
Equivalent Circuit (top view)



Handling Precaution

When handling individual devices (which are not yet mounting on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

Start of commercial production
2002-03



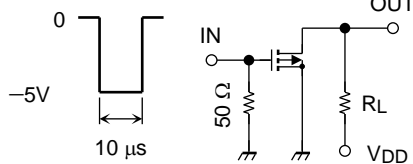
Weight: 0.003g(typ.)

Electrical Characteristics (Ta = 25°C) (Q1, Q2 common)

Characteristic	Symbol	Test Condition	MIN.	TYP.	MAX.	UNIT	
Gate leakage current	I_{GSS}	$V_{GS} = \pm 16\text{ V}, V_{DS} = 0\text{ V}$	—	—	± 1	μA	
Drain-Source breakdown voltage	$V_{(BR)DSS}$	$I_D = -0.1\text{ mA}, V_{GS} = 0\text{ V}$	-30	—	—	V	
Drain cut-off current	I_{DSS}	$V_{DS} = -30\text{ V}, V_{GS} = 0\text{ V}$	—	—	-1	μA	
Gate threshold voltage	V_{th}	$V_{DS} = -3\text{ V}, I_D = -0.1\text{ mA}$	-1.1	—	-1.7	V	
Forward transfer admittance	$ Y_{fs} $	$V_{DS} = -3\text{ V}, I_D = -10\text{ mA}$	20	—	—	mS	
Drain-Source ON resistance	$R_{DS(ON)}$	$I_D = -10\text{ mA}, V_{GS} = -4\text{ V}$	—	8	12	Ω	
		$I_D = -1\text{ mA}, V_{GS} = -2.5\text{ V}$	—	14	32		
Input capacitance	C_{iss}	$V_{DS} = -3\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	—	9.1	—	pF	
Reverse transfer capacitance	C_{rss}		—	3.5	—	pF	
Output capacitance	C_{oss}		—	8.6	—	pF	
Switching time	Turn-on time	t_{on}	$V_{DD} = -5\text{ V}, I_D = -10\text{ mA},$ $V_{GS} = 0\text{ V to } -5\text{ V}$	—	65	—	ns
	Turn-off time	t_{off}		—	175	—	

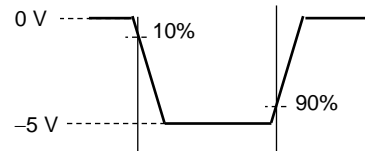
Switching Time Test Circuit

(a) Test circuit

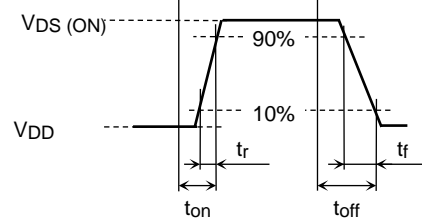


$V_{DD} = -5\text{ V}$
 Duty $\leq 1\%$
 V_{IN} : $t_r, t_f < 5\text{ ns}$
 $(Z_{out} = 50\ \Omega)$
 Common Source
 $T_a = 25^\circ\text{C}$

(b) VIN



(c) VOUT

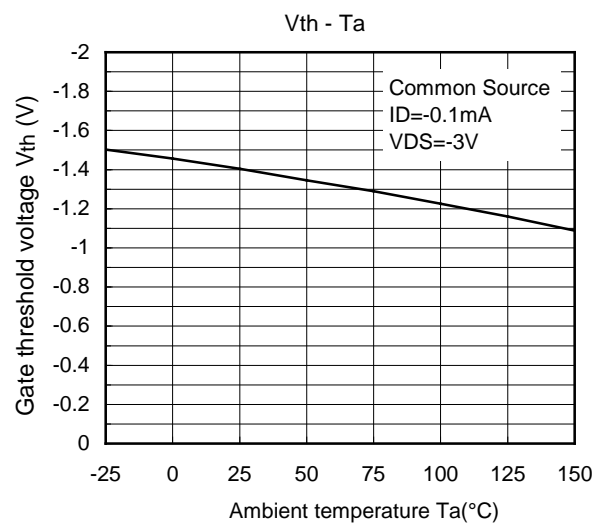
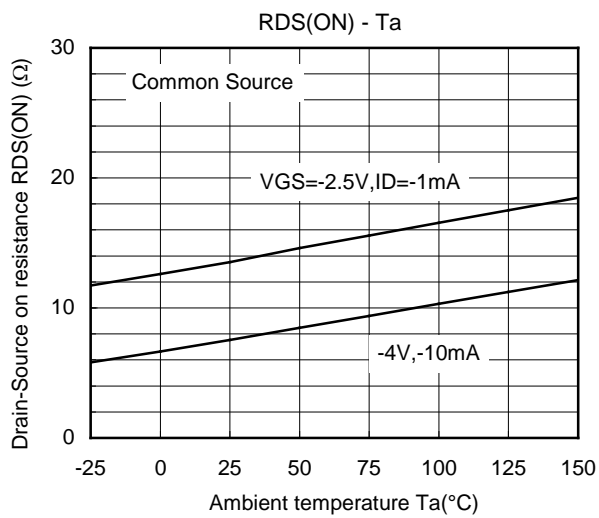
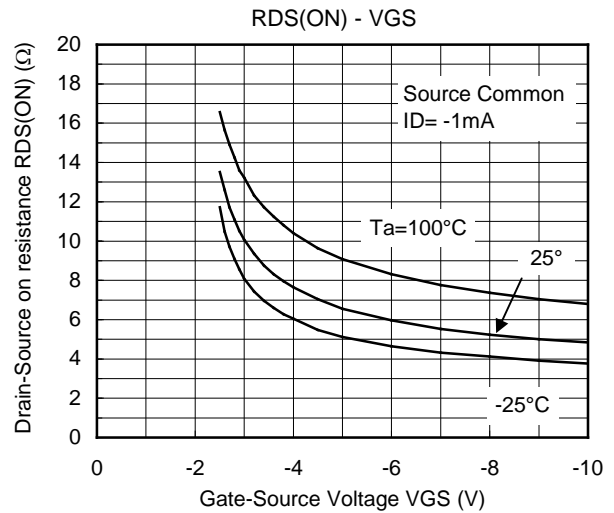
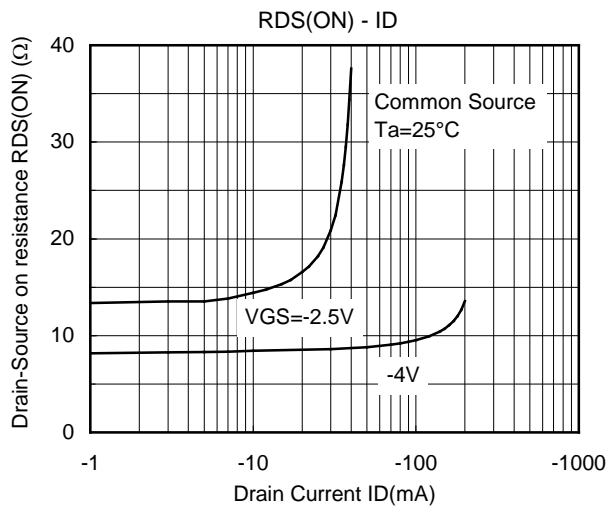
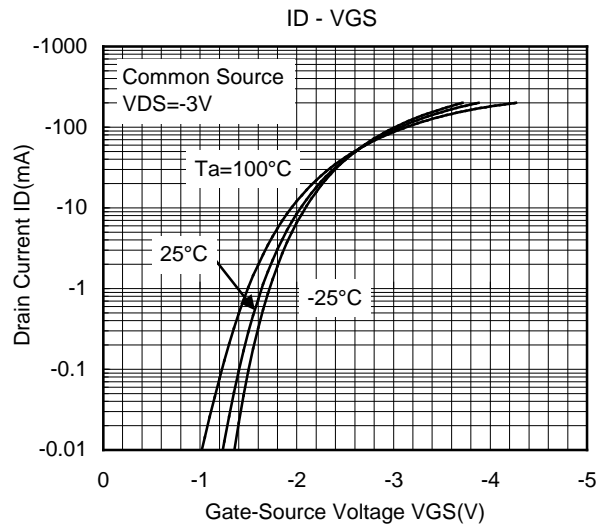
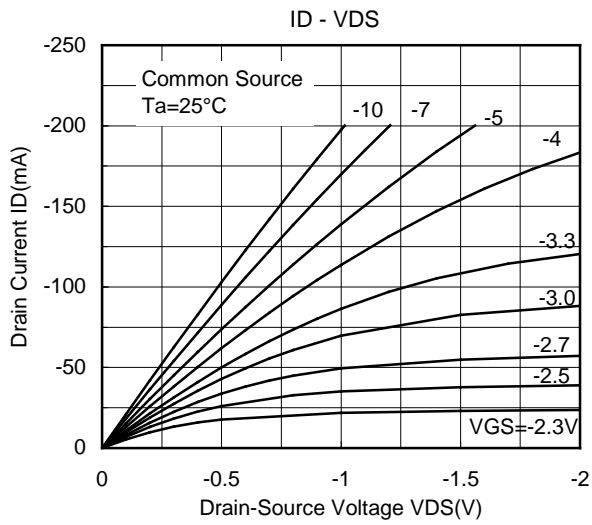


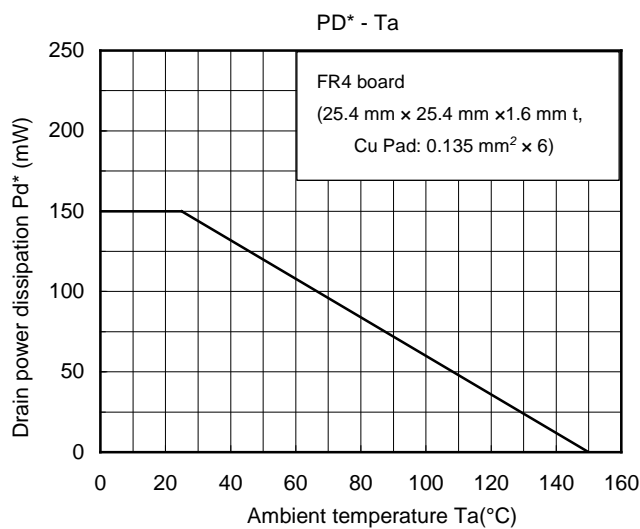
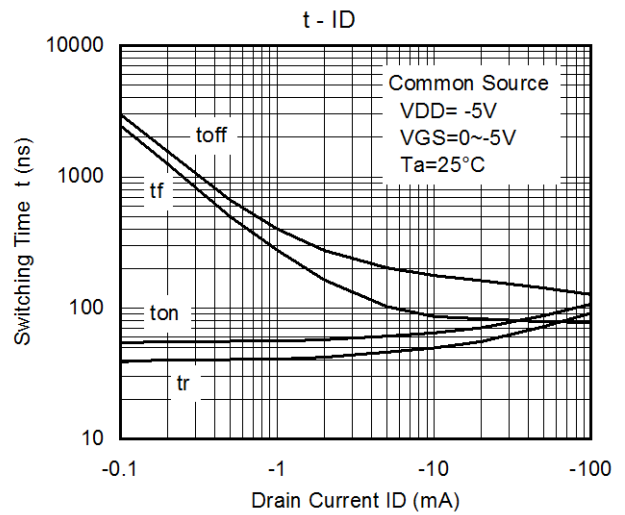
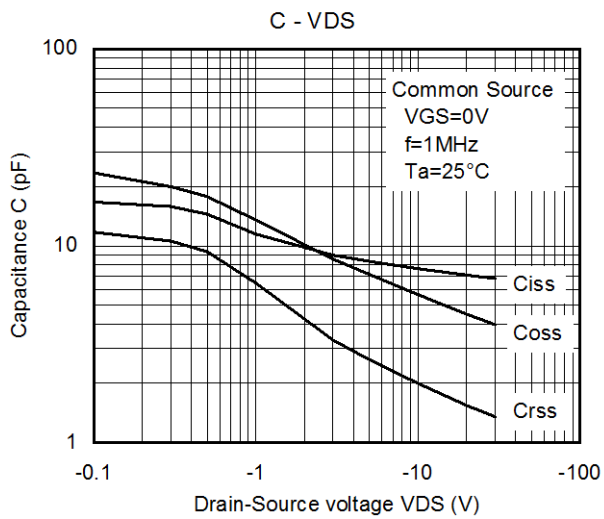
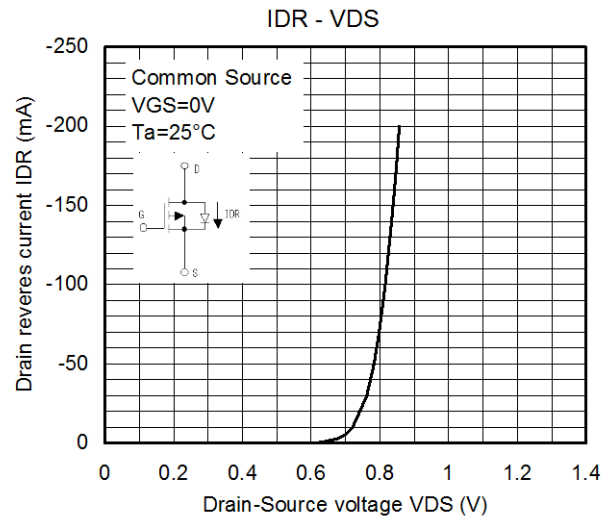
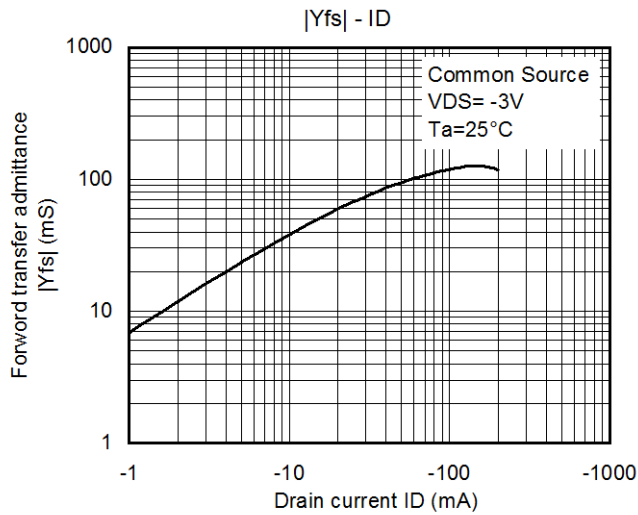
Precaution

V_{th} can be expressed as voltage between gate and source when low operating current value is $I_D = -100\ \mu\text{A}$ for this product. For normal switching operation, $V_{GS(on)}$ requires higher voltage than V_{th} and $V_{GS(off)}$ requires lower voltage than V_{th} . (Relationship can be established as follows: $V_{GS(off)} < V_{th} < V_{GS(on)}$)

Please take this into consideration for using the device.

Characteristics Curves





*: Total Rating

The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

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